

1N5817, 1N5818, 1N5819

1N5817 and 1N5819 are Preferred Devices

Axial Lead Rectifiers

This series employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features chrome barrier metal, epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

Features

- Extremely Low V_F
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- These are Pb-Free Devices*

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 0.4 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes:
260°C Max for 10 Seconds
- Polarity: Cathode Indicated by Polarity Band
- ESD Ratings: Machine Model = C (>400 V)
Human Body Model = 3B (>8000 V)



ON Semiconductor®

<http://onsemi.com>

**SCHOTTKY BARRIER
RECTIFIERS
1.0 AMPERE
20, 30 and 40 VOLTS**



MARKING DIAGRAM



A =Assembly Location
1N581x =Device Number
x= 7, 8, or 9
YY =Year
WW =Work Week
▪ =Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

1N5817, 1N5818, 1N5819

MAXIMUM RATINGS

Rating	Symbol	1N5817	1N5818	1N5819	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	20	30	40	V
Non-Repetitive Peak Reverse Voltage	V_{RSM}	24	36	48	V
RMS Reverse Voltage	$V_{R(RMS)}$	14	21	28	V
Average Rectified Forward Current (Note 1), ($V_{R(equiv)} \leq 0.2 V_R(dc)$, $T_L = 90^\circ C$, $R_{\theta JA} = 80^\circ C/W$, P.C. Board Mounting, see Note 2, $T_A = 55^\circ C$)	I_O	1.0			A
Ambient Temperature (Rated $V_R(dc)$, $P_{F(AV)} = 0$, $R_{\theta JA} = 80^\circ C/W$)	T_A	85	80	75	$^\circ C$
Non-Repetitive Peak Surge Current, (Surge applied at rated load conditions, half-wave, single phase 60 Hz, $T_L = 70^\circ C$)	I_{FSM}	25 (for one cycle)			A
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	T_J, T_{stg}	-65 to +125			$^\circ C$
Peak Operating Junction Temperature (Forward Current applied)	$T_{J(pk)}$	150			$^\circ C$

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL CHARACTERISTICS (Note 1)

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	80	$^\circ C/W$

ELECTRICAL CHARACTERISTICS ($T_L = 25^\circ C$ unless otherwise noted) (Note 1)

Characteristic	Symbol	1N5817	1N5818	1N5819	Unit
Maximum Instantaneous Forward Voltage (Note 2)	v_F	0.32	0.33	0.34	V
	($i_F = 0.1 A$)				
	($i_F = 1.0 A$)	0.45	0.55	0.6	
	($i_F = 3.0 A$)	0.75	0.875	0.9	
Maximum Instantaneous Reverse Current @ Rated dc Voltage (Note 2)	I_R	1.0	1.0	1.0	mA
	($T_L = 25^\circ C$)				
	($T_L = 100^\circ C$)	10	10	10	

- Lead Temperature reference is cathode lead 1/32 in from case.
- Pulse Test: Pulse Width = 300 μs , Duty Cycle = 2.0%.

1N5817, 1N5818, 1N5819

NOTE 3. — DETERMINING MAXIMUM RATINGS

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above $0.1 V_{RWM}$. Proper derating may be accomplished by use of equation (1).

$$T_{A(max)} = T_{J(max)} - R_{\theta JA} P_{F(AV)} - R_{\theta JA} P_{R(AV)} \quad (1)$$

where $T_{A(max)}$ = Maximum allowable ambient temperature
 $T_{J(max)}$ = Maximum allowable junction temperature (125°C or the temperature at which thermal runaway occurs, whichever is lowest)
 $P_{F(AV)}$ = Average forward power dissipation
 $P_{R(AV)}$ = Average reverse power dissipation
 $R_{\theta JA}$ = Junction-to-ambient thermal resistance

Figures 1, 2, and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2).

$$T_R = T_{J(max)} - R_{\theta JA} P_{R(AV)} \quad (2)$$

Substituting equation (2) into equation (1) yields:

$$T_{A(max)} = T_R - R_{\theta JA} P_{F(AV)} \quad (3)$$

Inspection of equations (2) and (3) reveals that T_R is the ambient temperature at which thermal runaway occurs or where $T_J = 125^\circ\text{C}$, when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2, and 3 as a difference in the rate of change of the slope in the vicinity of 115°C . The data of Figures 1, 2, and 3 is based upon dc conditions. For use in common rectifier circuits, Table 1 indicates suggested factors for an equivalent dc voltage to use for conservative design, that is:

$$V_{R(equiv)} = V_{in(PK)} \times F \quad (4)$$

The factor F is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes.

EXAMPLE: Find $T_{A(max)}$ for 1N5818 operated in a 12-volt dc supply using a bridge circuit with capacitive filter such that $I_{DC} = 0.4 \text{ A}$ ($I_{F(AV)} = 0.5 \text{ A}$), $I_{(FM)}/I_{(AV)} = 10$, Input Voltage = $10 V_{(rms)}$, $R_{\theta JA} = 80^\circ\text{C/W}$.

Step 1. Find $V_{R(equiv)}$. Read $F = 0.65$ from Table 1,

$$\therefore V_{R(equiv)} = (1.41)(10)(0.65) = 9.2 \text{ V}$$

Step 2. Find T_R from Figure 2. Read $T_R = 109^\circ\text{C}$

@ $V_R = 9.2 \text{ V}$ and $R_{\theta JA} = 80^\circ\text{C/W}$.

Step 3. Find $P_{F(AV)}$ from Figure 4. **Read $P_{F(AV)} = 0.5 \text{ W}$

$$\text{@ } \frac{I_{(FM)}}{I_{(AV)}} = 10 \text{ and } I_{F(AV)} = 0.5 \text{ A.}$$

Step 4. Find $T_{A(max)}$ from equation (3).

$$T_{A(max)} = 109 - (80)(0.5) = 69^\circ\text{C}.$$

**Values given are for the 1N5818. Power is slightly lower for the 1N5817 because of its lower forward voltage, and higher for the 1N5819.



Figure 1. Maximum Reference Temperature 1N5817



Figure 2. Maximum Reference Temperature 1N5818



Figure 3. Maximum Reference Temperature 1N5819

Table 1. Values for Factor F

Circuit	Half Wave		Full Wave, Bridge		Full Wave, Center Tapped* †	
	Resistive	Capacitive*	Resistive	Capacitive	Resistive	Capacitive
Sine Wave	0.5	1.3	0.5	0.65	1.0	1.3
Square Wave	0.75	1.5	0.75	0.75	1.5	1.5

**Note that $V_{R(PK)} \approx 2.0 V_{in(PK)}$.

†Use line to center tap voltage for V_{in} .

1N5817, 1N5818, 1N5819



Figure 4. Steady-State Thermal Resistance

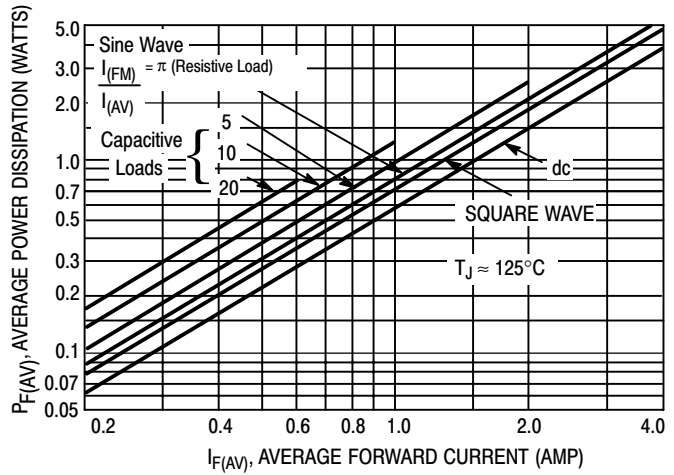


Figure 5. Forward Power Dissipation
1N5817-19



Figure 6. Thermal Response

NOTE 4. — MOUNTING DATA

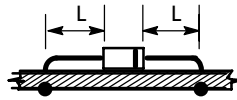
Data shown for thermal resistance, junction-to-ambient ($R_{\theta JA}$) for the mountings shown is to be used as typical guideline values for preliminary engineering, or in case the tie point temperature cannot be measured.

TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

Mounting Method	Lead Length, L (in)				$R_{\theta JA}$
	1/8	1/4	1/2	3/4	
1	52	65	72	85	$^{\circ}\text{C/W}$
2	67	80	87	100	$^{\circ}\text{C/W}$
3	50				$^{\circ}\text{C/W}$

Mounting Method 1

P.C. Board with 1-1/2" x 1-1/2" copper surface.

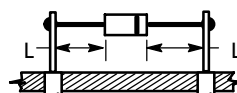


Mounting Method 3

P.C. Board with 1-1/2" x 1-1/2" copper surface.



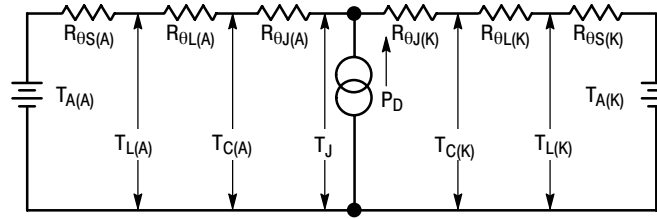
Mounting Method 2



VECTOR PIN MOUNTING

1N5817, 1N5818, 1N5819

NOTE 5. — THERMAL CIRCUIT MODEL (For heat conduction through the leads)



Use of the above model permits junction to lead thermal resistance for any mounting configuration to be found. For a given total lead length, lowest values occur when one side of the rectifier is brought as close as possible to the heatsink. Terms in the model signify:

- T_A = Ambient Temperature T_C = Case Temperature
- T_L = Lead Temperature T_J = Junction Temperature
- $R_{\theta S}$ = Thermal Resistance, Heatsink to Ambient
- $R_{\theta L}$ = Thermal Resistance, Lead to Heatsink
- $R_{\theta J}$ = Thermal Resistance, Junction to Case
- P_D = Power Dissipation

(Subscripts A and K refer to anode and cathode sides, respectively.) Values for thermal resistance components are:

- $R_{\theta L} = 100^\circ\text{C/W/in}$ typically and 120°C/W/in maximum
- $R_{\theta J} = 36^\circ\text{C/W}$ typically and 46°C/W maximum.



Figure 7. Typical Forward Voltage

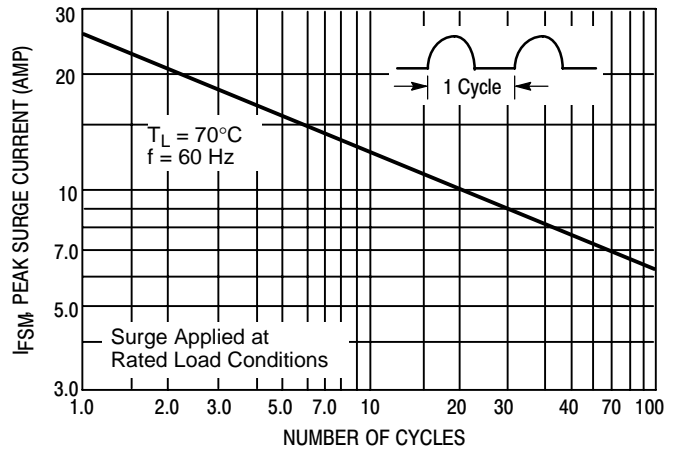


Figure 8. Maximum Non-Repetitive Surge Current



Figure 9. Typical Reverse Current

1N5817, 1N5818, 1N5819

NOTE 6. — HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 10.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss: it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.



Figure 10. Typical Capacitance

ORDERING INFORMATION

Device	Package	Shipping [†]
1N5817	Axial Lead*	1000 Units / Bag
1N5817G	Axial Lead*	1000 Units / Bag
1N5817RL	Axial Lead*	5000 / Tape & Reel
1N5817RLG	Axial Lead*	5000 / Tape & Reel
1N5818	Axial Lead*	1000 Units / Bag
1N5818G	Axial Lead*	1000 Units / Bag
1N5818RL	Axial Lead*	5000 / Tape & Reel
1N5818RLG	Axial Lead*	5000 / Tape & Reel
1N5819	Axial Lead*	1000 Units / Bag
1N5819G	Axial Lead*	1000 Units / Bag
1N5819RL	Axial Lead*	5000 / Tape & Reel
1N5819RLG	Axial Lead*	5000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*This package is inherently Pb-Free.

1N5817, 1N5818, 1N5819

PACKAGE DIMENSIONS

AXIAL LEAD CASE 59-10 ISSUE U




NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. ALL RULES AND NOTES ASSOCIATED WITH JEDEC DO-41 OUTLINE SHALL APPLY
4. POLARITY DENOTED BY CATHODE BAND.
5. LEAD DIAMETER NOT CONTROLLED WITHIN F DIMENSION.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.161	0.205	4.10	5.20
B	0.079	0.106	2.00	2.70
D	0.028	0.034	0.71	0.86
F	----	0.050	----	1.27
K	1.000	----	25.40	----

STYLE 1:

1. CATHODE (POLARITY BAND)
2. ANODE

ON Semiconductor and  are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free
USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com

Order Literature: <http://www.onsemi.com/orderlit>

For additional information, please contact your local
Sales Representative

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9